Electronic Acknowledgement Receipt				
EFS ID:	1306776			
Application Number:	09712749			
International Application Number:				
Confirmation Number:	9765			
Title of Invention:	Low profile integrated module interconnects and method of fabrication			
First Named Inventor/Applicant Name:	Chia-Yu Fu			
Customer Number:	23125			
Filer:	David George Dolezal/Dora Hudgins			
Filer Authorized By:	David George Dolezal			
Attorney Docket Number:	CT00-020			
Receipt Date:	10-NOV-2006			
Filing Date:	14-NOV-2000			
Time Stamp:	16:45:32			
Application Type:	Utility			
Payment information:				

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Request for status of Application	CT00-020-US-2006-11-10-St atusReport.pdf	125232	no	1
Warnings:					

Information:		
	Total Files Size (in bytes):	125232

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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.